DECLARATION FOR PATENT APPLICATION (WITH POWER OF ATTORNEY)

As an inventor named below or on any attached continuation page, I hereby declare that: My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled WAFER CLEANING METHOD AND RESULTING WAFER, the specification of which (check one):

\bowtie	is attached hereto.								
	was filed on	as United States app	lication serial no.	and					
	was amended on								
	was filed on	as PCT international a	application no.	and					
	was amended under PCT	Article 19 on	·						
I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.									
known to me	owledge the duty to disclo to be material to the patent is defined in Title 37, Cod-	ability of the subject matte	er claimed in this						
I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate or § 365(a) of any PCT international application(s) designating at least one country other than the United States of America listed below and on any attached continuation page and have also identified below and on any attached continuation page any foreign application for patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America having a filing date before that of the application(s) on which priority is claimed.									
Prior foreign/PCT application(s): Priority Claimed									
			Honey	Ciannica					
(numb	er) (count	ry) (day/month/year i	îled) Yes	No					
(numb	er) (count	ry) (day/month/year t	filed) Yes	No					

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) or § 365(c) of PCT international application(s) designating the United States of America listed below and on any attached continuation page and, insofar as the subject matter of each of the claims of this application is not disclosed in any such prior application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations § 1.56 which became available

DECLARATION FOR PATENT APPLICATION

(continuation page)

Invention Title: WAFER CLEANING METHOD AND RESULTING WAFER

(application serial no.)	(filing date)	(status-pending, patented or abandoned		
(application serial no.)	(filing date)	(status-pending, patented or abandoned		
I hereby claim the benefit u isional application(s) listed bel		tes Code, § 119(e) of any United Stat		

transact all business in the Patent and Trademark Office connected therewith:

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DECLARATION FOR PATENT APPLICATION

(continuation page)

Invention Title: WAFER CLEANING METHOD AND RESULTING WAFER

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Inventor's signature	Date	7.21.	0	
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